

9097250 TOSHIBA (DISCRETE/OPTO)

99D 16896 DT-39-11



SEMICONDUCTOR

TECHNICAL DATA

TOSHIBA FIELD EFFECT TRANSISTOR
 YTF832
 SILICON N CHANNEL MOS TYPE
 (π -MOS II)

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS.
 CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR
 DRIVE APPLICATIONS.

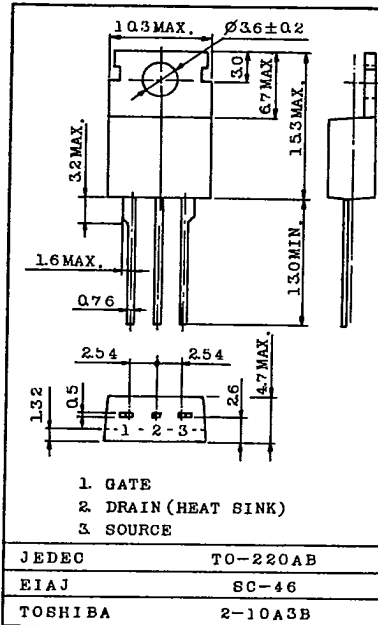
FEATURES:

- . Low Drain-Source ON Resistance : $R_{DS(ON)}=1.5\Omega$ (Typ.)
- . High Forward Transfer Admittance : $|Y_{fs}|=3.25S$ (Typ.)
- . Low Leakage Current : $I_{GSS}=\pm 500nA$ (Max.) @ $V_{GS}=\pm 20V$
 $I_{DSS}=250\mu A$ (Max.) @ $V_{DS}=500V$
- . Enhancement-Mode : $V_{th}=2.0\sim 4.0V$ @ $V_{DS}=V_{GS}, I_D=250\mu A$

MAXIMUM RATINGS (Ta=25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DSX}	500	V
Drain-Gate Voltage ($R_{GS}=1M\Omega$)	V_{DGR}	500	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current	DC(Tc=25°C)	I_D	4
	DC(Tc=100°C)	I_D	2.5
	Pulse	I_{DP}	16
Inductive Current (Clamped)	I_{LP}	16	A
Drain Power Dissipation (Tc=25°C)	P_D	75	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature Range	T_{stg}	-55~150	°C

INDUSTRIAL APPLICATIONS
 Unit in mm



Weight : 1.9g

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	1.67	°C/W
Thermal Resistance, Junction to Ambient	$R_{th(j-a)}$	80	°C/W
Maximum Lead Temperature for Soldering Purposes (1.6mm from case for 10 seconds)	T_L	300	°C

TOSHIBA CORPORATION

GT1A2

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Y T F 8 3 2

ELECTRICAL CHARACTERISTICS (Ta=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Gate Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 500	nA	
Drain Cut-off Current	I_{DSS}	$V_{DS}=500V, V_{GS}=0V, T_c=25^\circ C$	-	-	250	μA	
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=250\mu A, V_{GS}=0V$	500	-	-	V	
Gate Threshold Voltage	V_{th}	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	-	4.0	V	
Forward Transfer Admittance	$ Y_{fs} $	$V_{DS}=10V, I_D=2.5A$	2.5	3.25	-	S	
On-State Drain Current	$I_{D(ON)}$	$V_{DS}=10V, V_{GS}=10V$	4	-	-	A	
Drain-Source ON Resistance	$R_{DS(ON)}$	$I_D=2.5A, V_{GS}=10V$	-	1.5	2.0	Ω	
Drain-Source ON Voltage	$V_{DS(ON)}$	$I_D=4.5A, V_{GS}=10V$	-	7.4	9.4	V	
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1MHz$	-	600	800	pF	
Reverse Transfer Capacitance	C_{rss}		-	40	60	pF	
Output Capacitance	C_{oss}		-	150	200	pF	
Switching Time	Rise Time	t_r		-	15	30	ns
	Turn-on Time	t_{on}		-	30	60	ns
	Fall Time	t_f		-	15	30	ns
	Turn-off Time	t_{off}		-	40	85	ns
Total Gate Charge (Gate-Source Plus Gate-Drain)	Q_g	$V_{GS}=10V, I_D=6A,$	-	22	30	nC	
Gate Source Charge	Q_{gs}	$V_{DS}=400V$	-	11	-	nC	
Gate-Drain ("Miller") Charge	Q_{gd}		-	11	-	nC	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Source Current	I_S	—	-	-	4	A
Pulse Source Current	I_{SP}	—	-	-	16	A
Diode Forward Voltage	V_{SD}	$I_S=4A, V_{GS}=0V, T_c=25^\circ C$	-	-	1.5	V
Reverse Recovery Time	t_{rr}	$T_j=150^\circ C, I_F=4.5A,$	-	800	-	ns
Reverse Recovered Charge	Q_{rr}	$dI_F/dt=100A/\mu s$	-	4.6	-	μC

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